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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/628,690	07/28/2003	Etsuro Morita	JG-SU-5004C/500577.20052	6077

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EXAMINER

SONG, MATTHEW J

ART UNIT PAPER NUMBER

1765

DATE MAILED: 02/04/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

10/628,690

Applicant(s)

MORITA ET AL.

Examiner

Matthew J Song

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— The MAILING DATE of this communication appears on the cover sheet with the correspondence address —

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 12 November 2004.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 6 and 23-32 is/are pending in the application.
- 4a) Of the above claim(s) 23-32 is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 6 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. _____.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- 1) ☒ Notice of References Cited (PTO-892)
- 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948)
- 3) ☐ Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date _____
- 4) ☐ Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____
- 5) ☐ Notice of Informal Patent Application (PTO-152)
- 6) ☐ Other: _____

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DETAILED ACTION

Election/Restrictions

1. Applicant's election without traverse of Group I, claim 6 in the reply filed on 11/12/2004 is acknowledged.

2. Claims 23-32 are withdrawn from further consideration pursuant to 37 CFR 1.142(b) as being drawn to a nonelected invention, there being no allowable generic or linking claim.

Election was made **without** traverse in the reply filed on 11/12/2004.

Claim Objections

3. Claim 6 is objected to because of the following informalities: Claim 6 recites, "wherein said heat treatment of said silicon wafer at step (c) is carried out in a 100% hydrogen atmosphere, a mixed atmosphere of hydrogen and nitrogen". The Examiner suggests inserting "or" between the 100% hydrogen atmosphere and a mixed atmosphere of hydrogen and nitrogen to clarify the claim. Appropriate correction is required.

Claim Rejections - 35 USC § 103

4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

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This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

5. Claim 6 is rejected under 35 U.S.C. 103(a) as being unpatentable over Abe et al (EP 0926718 A2) in view of Hourai et al (US 5,954,873) or Yokoyama et al (US 6,179,910).

Abe et al discloses a method of heat treating a silicon monocrystalline wafer at 1200°C or above for 30 minutes or more in a reducing atmosphere of 100% hydrogen or a mixed atmosphere of hydrogen and argon to decrease the crystal originated particle (COP) density to zero ([0044]). Abe et al also discloses growing a silicon monocrystal ingot by the Czochralski method, this reads on applicants' pulling a single crystal ingot from a silicon melt, and obtaining a wafer by slicing the ingot ([0016]). Abe et al also discloses growing the silicon ingot at a growth rate greater than 0.6 mm/min, such that one void COPs exist in a high density (claims 2-7). Abe et al also discloses a single type defect in light scattering tomography defect (LSTD) in a rapidly cooled CZ crystal with COPs existing in a silicon monocrystal subjected to the heat treatment preferably have a size of 60-130 nm (0.06-0.13 μm) ([0022] and [0034]-[0036]) and the number of COPs was 90 per 8 inch wafer ([0068]), which can be determined to be approximately 0.069 pieces/cm².

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Abe et al does not teach pulling up the ingot such that V/G_a and V/G_b become 0.23-0.50 $\text{mm}^2/\text{minute } ^\circ\text{C}$, respectively, both of V/G_a and V/G_b exceeding a first critical ratio for restricting vacancy agglomerates to a vacancy point defect dominant domain at the center of the ingot.

In a method of manufacturing a silicon single crystal, Hourai et al teaches the V/G value effects the density and distribution of all types of defects in the crystal, where V is the pulling rate (mm/min) and G is the inside-crystal gradient in the direction of the pulling axis in a high temperature zone from the melting point of silicon to 1300°C (col 4, ln 30-67). Hourai et al also teaches an infrared scattering defect developing region is obtained at V/G ratios of greater than approximately 0.23 and a high pulling rate of V_1 the ingot is almost entirely (Fig 2 and col 3, ln 15-25). It would have been obvious to a person of ordinary skill in the art at the time of the invention to modify Abe et al by using the V/G for the center and edge taught by Hourai et al to produce a crystal containing the light scattering defects desired by Abe et al.

The combination of Abe et al and Hourai et al teach heat treating at a temperature of 1200°C or above for 30 minutes or more ('718 Abstract), which overlap the claimed range of $1050\text{-}1220^\circ\text{C}$ for 30-150 minutes. Overlapping ranges are held to be obvious (MPEP 2144.05).

The combination of Abe et al and Hourai et al teach pulling a single crystal ingot under the claimed pulling conditions and heat treating in a similar method, as claimed by applicants. The combination of Abe et al and Hourai et al also teach the heat treatment decrease the density of COPs and the number of COPs with a size of $0.2\text{-}0.12\text{ }\mu\text{m}$ is $0.069\text{ pieces}/\text{cm}^2$. The combination of Abe et al and Hourai et al is silent to the number of COPs with a size less than $0.12\text{ }\mu\text{m}$. However, since the combination of Abe et al and Hourai et al teach pulling a crystal

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and heat treating a wafer, as claimed by applicants, and the heat treatment is known to reduce COPs; the claimed number of COPs smaller than $0.12\ \mu\text{m}$ is inherent to the combination of Abe et al and Hourai et al.

6. Claim 6 is rejected under 35 U.S.C. 103(a) as being unpatentable over Yokoyama et al (US 6,179,910).

In a method of manufacturing silicon, Yokoyama et al teaches a V/G ratio greater than $0.25\ \text{mm}^2/^{\circ}\text{C min}$ produces a silicon ingot with only a void effect region (Fig 2). Yokoyama et al also teaches pulling under a condition of V/G values smaller than $0.25\ \text{mm}^2/^{\circ}\text{C}$ to miniaturize the sizes of void defects and the wafers are heat treated by hydrogen gas so as to eliminate void defects (col 3, ln 1-41). Yokoyama et al also teaches G is measured at a temperature near the melting point at sites along its crystal axis, this reads on applicants' center and edge because Yokoyama et al teaches points along the axis which includes the center and edge of the ingot (col 3, ln 35-45). Yokoyama et al also teaches manufacturing crystals with a V/G value smaller than $0.3\ \text{mm}^2/^{\circ}\text{C min}$ suitable for hydrogen heat treatment (col 9, ln 50 to col 10, ln 45). Yokoyama et al also teaches a hydrogen heat treatment of 1200°C for 1 hour (col 6, ln 20-55), this reads on applicants' heat treatment of a 100% hydrogen atmosphere at a temperature of $1050\text{-}1220^{\circ}\text{C}$ for 30-150 minutes. Yokoyama et al teaches wafers cut from a silicon single crystal (col 4, ln 10-25).

Yokoyama et al teach pulling a single crystal ingot under the claimed pulling conditions and heat treating in a similar method, as claimed by applicants. Yokoyama et al also teach the heat treatment decreases the number of defects. Yokoyama et al is silent to the claimed number

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of COPs resulting from the heat treatment. However, since Yokoyama et al teaches a similar method of pulling a crystal and heat treating a wafer, as claimed by applicants, the claimed number of COPs is inherent to Yokoyama et al.

Yokoyama et al teaches V/G of less than $0.25 \text{ mm}^2/\text{°C min}$. Overlapping ranges are held to be obvious (MPEP 2144.05).

Conclusion

7. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Park et al (US 6,472,040) teaches critical V/G ratios for controlling defect distribution (col 9, ln 30-65).

Fusegawa et al (US 5,834,322) teaches pulling a silicon single crystal at a speed not less than 0.8 mm/min, slicing wafers from the ingot and heat treating the wafers in a temperature range of 1150-1280°C for 10-120 minutes to eliminate defects (col 3, ln 1-67).

Falster et al (US 2003/0051657) teaches controlling V/G to form vacancy dominated silicon single crystals ([0044]-[0047] and Abstract).

8. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Matthew J Song whose telephone number is 571-272-1468. The examiner can normally be reached on M-F 9:00-5:00.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nadine Norton can be reached on 571-272-1465. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Matthew J Song
Examiner
Art Unit 1765

MJS
January 26, 2005

NADINE G. NORTON
SUPERVISORY PATENT EXAMINER

